

Electronic Patent Application Fee Transmittal

Application Number:	10551745
Filing Date:	19-Mar-2007
Title of Invention:	Diffusion Soldered Semiconductor Device and Method
First Named Inventor/Applicant Name:	Edmund Riedl
Filer:	Mark L. Gleason/Katy Henry
Attorney Docket Number:	I431.131.101/FIN 421 PCT/

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Claims in excess of 20	1615	2	52	104
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Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				104